

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	210	faris near: sadeg	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:42
S2	6	((("5786629") or ("6257564") or ("5534073"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 08:36
S3	2	"5967577"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/01 08:36
S4	7	("3404845"   "4049484"   "4787290"   "5243841"   "5284287"   "5516125"   "5749614").PN.	USPAT	OR	ON	2003/10/01 08:37
S5	4	("2247623"   "3138508"   "3377096"   "3926710").PN.	USPAT	OR	ON	2003/10/01 08:38
S6	19	"4049484".URPN.	USPAT	OR	ON	2003/10/01 08:39
S7	8	("2953808"   "3523707"   "3631796"   "3743340"   "4049484"   "4674785"   "4712784"   "4799722").PN.	USPAT	OR	ON	2003/10/01 08:40
S8	1	"2953808".PN.	USPAT	OR	ON	2003/10/01 08:41
S9	7	"4799722".URPN.	USPAT	OR	ON	2003/10/01 08:41
S10	11	("1575892"   "2852253"   "2984398"   "3137390"   "3334896"   "3421753"   "3504910"   "3617048"   "3815762"   "4216955"   "4327906").PN.	USPAT	OR	ON	2003/10/01 08:42
S11	7	"4881770".URPN.	USPAT	OR	ON	2003/10/01 08:43
S12	12	("2964007"   "3226255"   "3910621"   "4506820"   "4739919"   "4745679"   "4787662"   "4881770"   "5284287"   "5749614"   "5834062"   "5839641").PN.	USPAT	OR	ON	2003/10/01 08:43
S13	6	("1842383"   "3556578"   "4352440"   "4452557"   "4479298"   "4703966").PN.	USPAT	OR	ON	2003/10/01 08:50
S14	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46
S15	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46

S16	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S17	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S18	1365	(294/64.1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01-09-28
S19	3	("3893881"   "5177857"   "6173648").PN.	USPAT	OR	ON	2003/10/01 08:52
S20	2	"6336492".URPN.	USPAT	OR	ON	2003/10/01 08:53
S21	20	("3221910"   "3831992"   "4461328"   "4468974"   "4478094"   "4500247"   "4565100"   "4604024"   "4852620"   "4909992"   "4952518"   "5063790"   "5192511"   "5293179"   "5334352"   "5343909"   "5392914"   "5497670"   "5736105"   "5807524").PN.	USPAT	OR	ON	2003/10/01 08:54
S22	12	("2964007"   "3226255"   "3910621"   "4506820"   "4739919"   "4745679"   "4787662"   "4881770"   "5284287"   "5749614"   "5834062"   "5839641").PN.	USPAT	OR	ON	2003/10/01 08:56
S23	3	("4131267"   "4684113"   "4693458").PN.	USPAT	OR	ON	2003/10/01 08:59
S24	3	("3102751"   "3865420"   "4047532").PN.	USPAT	OR	ON	2003/10/01 09:03
S25	1	"4846517".URPN.	USPAT	OR	ON	2003/10/01 09:03
S26	9	("1945481"   "2694337"   "2782574"   "2814233"   "2895706"   "3107078"   "3180608"   "4448404"   "4468017").PN.	USPAT	OR	ON	2003/10/01 09:05
S27	16	"4721462".URPN.	USPAT	OR	ON	2003/10/01 09:06
S28	3	("3523707"   "3888725"   "4375126").PN.	USPAT	OR	ON	2003/10/01 09:09
S29	9	"4452557".URPN.	USPAT	OR	ON	2003/10/01 09:09
S30	13	"2572640".URPN.	USPAT	OR	ON	2003/10/01 09:16
S31	273	(239/553.5).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:34

S32	491	(156/538).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:35
S33	6	((("5967577") or ("6336492") or ("5564682"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/27 10:06
S34	0	bunding and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S35	0	bunding and carrying and (sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S36	1	bunding and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 11:01
S37	167	(294/152).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/05/05 11:01
S38	100	(294/64.3).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S39	64	(294/64.2).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S40	1	silicon and (vaccum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43

S41	0	(semiconductor near material) and (vaccum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43
S42	1	(semiconductor near material) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:44
S43	1	(semiconductor near materials) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:45
S44	3	(semiconductor same material) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:51
S45	0	(Si-oxide) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:52
S46	2	(Si-oxide) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:53
S47	6192	(Silicon) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S48	159	(Silicon) and (vacuum near system) and (vacuum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:54
S49	1	S48 and "294"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S50	8	S48 and "414"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:55

S51	2258	(Silicon S-oxide) and (vacuum near system) and body	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S52	2	S51 and "294"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04